нувкі іс M57140-01

IPM POWER SUPPLY HYBRID IC



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
А	2.03	51.5
В	0.71	18.0 MAX
С	.39±.06	12.5±1.5
D	.18±.06	4.5±1.5
Е	0.07	1.8

Dimensions	Inches	Millimeters
F	0.02	0.55
G	0.08	2.1
Н	0.08	2.1
J	1.13	28.8



Description:

M57140-01 is an isolated DC-to-DC converter designed to drive IPMs (Intelligent Power Modules). With an input of DC 20V, the module supplies four 15V outputs. Isolation is provided from primary to secondary and also between the secondaries. Interwinding isolation is designed for driving the IPM.

Features::

- Output Specification: +15V x 4, Total 3W max.
- Primary-to-secondary Isolation: 2500 V_{RMS}, One Minute
- Secondary-to-secondary Isolation Voltage: 1500 V_{RMS}, One Minute
- Compact, Low Profile Design

Applications:

- IPMs for General Purpose
 Inverter and AC Servo
- Power Source for MOSFET Driving Circuits

Ordering Information:

M57140-01



M57140-01

IPM POWER SUPPLY HYBRID IC

Absolute Maximum Ratings, V_{IN} = 20V, T_a = 25 $\,^\circ\text{C}$ unless otherwise specified

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Item	Symbol	Test Conditions	Limit	Units
Input Voltage	V _{IN}	Terminals $(4), (5), (6-1), (2), (3)$	25	Volts
Load Current	IL Terminals 14-13, 12-11, 10-9		30	mA
	-	Terminals 8-7	100	mA
Operating Temperature	T _{opr}	There Should be	-10 ~ +75	°C
Storage Temperature	T _{stg}	No Condensation	-20 ~ +85	°C
Internal Power Dissipation	Pd	Ð	1.5	Watts
Primary-to-Secondary Isolation		1 Minute	2500	V _{rms}
Secondary-to-Secondary Isolation		1 Minute	1500	V _{rms}

Electrical Characteristics, V_{IN} = 20V, T_a = 25 $\,^{\circ}\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Input Source Voltage	V _{IN}	Direct Current	18	20	22	Volts
Output Voltage	Vo	Between Pins 10-9, 12-11, 14-13,	13.5	15.0	16.5	Volts
		I _L = 30mA				
	-	Between Pins (8)-(7), $I_L = 100 \text{mA}$	13.5	15.0	16.5	Volts
Peak Load Current	I _{LP}	Between Pins 10-9, 12-11, 14-13	Ð	33	Ð	mA
	-	Between Pins 8-7	Ð	110	Ð	mA
Load Regulation	Reg-out	Between Pins 10-9, 12-11, 14-13,	Ð	5	10	%
		I _L = 0 ~ 30mA				
	-	Between Pins (8) - (7) , I _L = 0 ~ 100mA	Ð	7	12	%
Efficiency	η	Between Pins 10-9, 12-11, 14-13,	Ð	70	Ð	%
		I _L = 30mA				
	-	Between Pins (8) - (7) , I _L = 100mA	Ð	70	Ð	%

Application Circuit



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Application Circuit



Handling Precautions:

- When M57140-01 is used under excessive load condition, output side rectifying diodes will be destroyed. Care should be exercised so as not to operate the device above the rated maximum load current.
- Coating Materials should not be applied on this device because the application of coating materials for waterproofing could cause a stress and destroy a device.

M57140-01



IHYBRID IC **M57140-01**

IPM POWER SUPPLY HYBRID IC

FOR SAFETY USING

Great detail and careful attention are given to the production activity of Hics, such as the development, the quality of production, and in it's reliability. However the reliability of Hics depends not only on their own factors but also in their condition of usage. When handling Hics, please note the following cautions.

CAUTIONS		
Packing	The materials used in packing Hics can only withstand normal external conditions. When exposed to outside shocks, rain and certain environmental contaminators, the packing materials will deteriorates. Please take care in handling.	
Carrying	 Don't stack boxes too high. Avoid placing heavy materials on boxes. Boxes must be positioned correctly during transportation to avoid breakage. Don't throw or drop boxes. Keep boxes dry. Avoid rain or snow. Minimal vbration and shock during transportation is desirable. 	
Storage	 When storing Hics, please observe the following notices or possible deterioration of their electrical characteristics, risk of solder ability, and external damage may occur. 1) Devices must be stored where fluctuation of temperature and humidity is minimal, and must not be exposed to direct sunlight. Store at the normal temperature of 5 to 30 degrees Celsius with humidity at 40 to 60%. 2) Avoid locations where corrosive gasses are generated or where much dust accumulates. 3) Storage cases must be static proof. 4) Avoid putting weight on boxes. 	
Extended storage	When extended storage is necessary, Hics must be kept non-processed. When using Hics which have been stored for more than one year or under severe conditions, be sure to check that the exterior is free from flaw and other damages.	
Maximum ratings	To prevent any electrical damages, use Hics within the maximum ratings. The temperature, current, voltage, etc. must not exceed these conditions.	
Polarity	To protect Hics from destruction and deterioration due to wrong insertion, make sure of polarity in inserting leads into the board holes, conforming to the external view for the terminal arrangement.	

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Marketing division, Marketing planning department

6-41 Tsukuba, Isahaya, Nagasaki, 854-0065 Japan

Keep safety first in your circuit designs!

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